### Si4403DDY

**Vishay Siliconix** 

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P-Channel 20 V (D-S) MOSFET



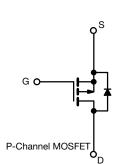
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-20				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.0140				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.0200				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.8 V	0.0300				
Q <sub>g</sub> typ. (nC)	39				
I <sub>D</sub> (A)	-15.4 <sup>e</sup>				
Configuration	Single				

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen III p-channel power MOSFET
- 1.8 V rated R<sub>DS(on)</sub>
- 100% R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- · Adapter switch
- Load switch
- DC/DC converters
- High speed switching
- Power management in battery-operated, mobile and wearable devices



ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4403DDY-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	-20	V
Gate-source voltage		V <sub>GS</sub>	± 8	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-15.4 <sup>e</sup>	
	T <sub>C</sub> = 70 °C		-12.3	
	T <sub>A</sub> =25 °C	I <sub>D</sub>	-10.9 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	1	-8.7 <sup>b, c</sup>	А
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-32 <sup>a</sup>	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-4.2	
	T <sub>A</sub> = 70 °C	Is Is	-2 <sup>b, c</sup>	
Maximum power dissipation	T <sub>C</sub> = 25 °C		5	
	T <sub>C</sub> = 70 °C		3.2	14/
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.4 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C	1 -	1.5 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	
Soldering recommendations (peak temperature)			260	°C

#### THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	41	52	°C/W	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	20	25	C/W	

#### Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 100 °C/W

e. T<sub>C</sub> = 25 °C

S17-0318-Rev. A, 27-Feb-17

1

Document Number: 70094

Pb-free



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-20	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-12.5	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	26.5	-	mV/°(	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-	-1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 8 V	-	-	± 100	nA	
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1		
Zero gate voltage drain current	IDSS	$V_{DS}$ = -20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	-	-	-10	μA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-5	-	-	Α	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -9 \text{ A}$	-	0.0105	0.0140	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -6 \text{ A}$	-	0.0140	0.0200		
		$V_{GS} = -1.8 \text{ V}, \text{ I}_{D} = -3 \text{ A}$	-	0.0190	0.0300		
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -9 \text{ A}$	-	45	-	S	
Dynamic <sup>b</sup>			•		•		
Input capacitance	C <sub>iss</sub>		-	3250	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS}$ = -10 V, $V_{GS}$ = 0 V, f = 1 MHz	-	340	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	325	-		
	Qg	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -8 \text{ V}, \text{ I}_{D} = -5 \text{ A}$	-	66	99		
Total gate charge		$V_{DS}$ = -10 V, $V_{GS}$ = -4.5 V, $I_D$ = -5 A	-	39	59	]	
Gate-source charge	Q <sub>gs</sub>		-	3.7	-	nC	
Gate-drain charge	Q <sub>gd</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	7.9	-	1	
Gate resistance	Rg	f = 1 MHz	0.7	3.7	7.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	21	40		
Rise time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 2 \Omega, \text{ I}_{D} \cong -5 \text{ A},$	-	25	50	1	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -4.5 V, $R_g$ = 1 $\Omega$	-	70	140		
Fall time	t <sub>f</sub>		-	24	50		
Turn-on delay time	t <sub>d(on)</sub>		-	9	20	ns	
Rise time	tr	$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 2 \Omega, \text{ I}_{D} \cong -5 \text{ A},$	-	18	35		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -8 V, R_g = 1 \Omega$	-	74	150		
Fall time	t <sub>f</sub>		-	20	40		
Drain-Source Body Diode Characteristi	cs						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-5.2		
Pulse diode forward current	I <sub>SM</sub>		-	-	-32	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -5 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	31	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	20	40	nC	
Reverse recovery fall time	t <sub>a</sub>	$I_F = -5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	_	12	-		
Reverse recovery rise time	t <sub>b</sub>		_	19	_	ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

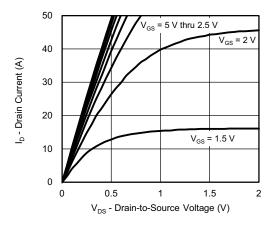
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

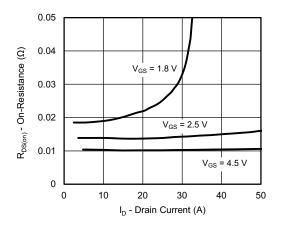


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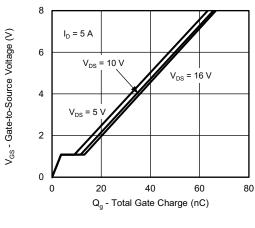
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



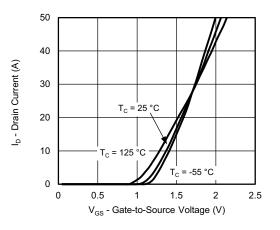
**Output Characteristics** 



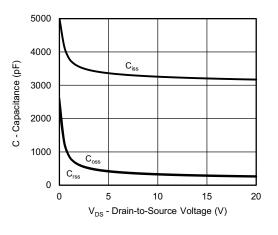
**On-Resistance vs. Drain Current and Gate Voltage** 



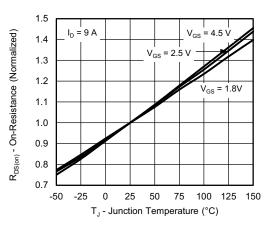
Gate Charge



**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

3

Document Number: 70094

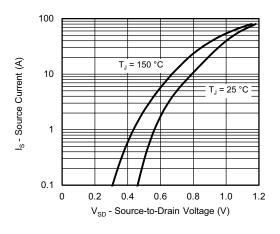
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S17-0318-Rev. A, 27-Feb-17

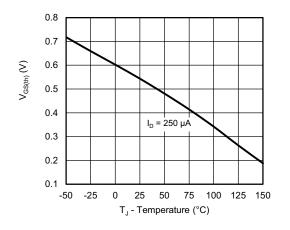


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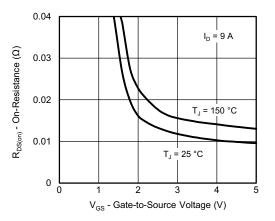
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



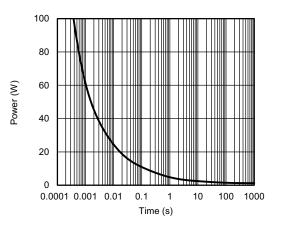
Source-Drain Diode Forward Voltage



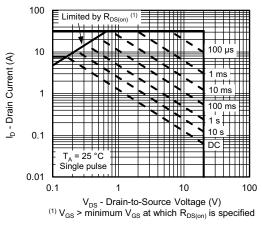
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

S17-0318-Rev. A, 27-Feb-17

4

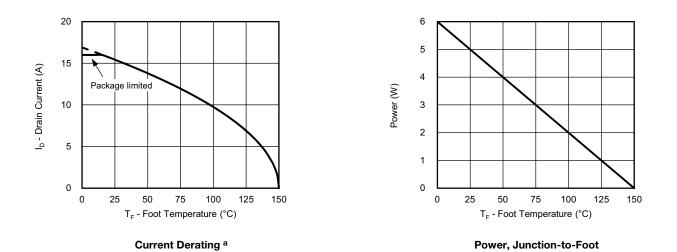
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Note

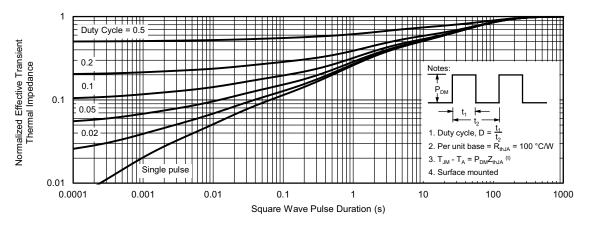
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



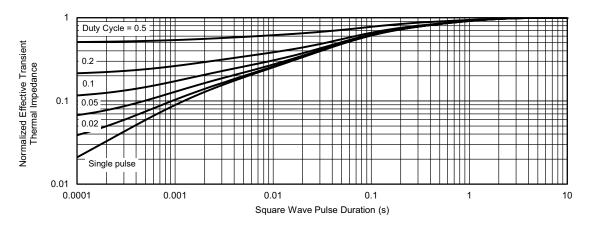
**Si4403DDY** 

**Vishay Siliconix** 

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?70094.

6



## Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

### **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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